

APPENDIX IV

STATUTORY AND GENERAL INFORMATION

FURTHER INFORMATION ABOUT OUR COMPANY

1. Incorporation of Our Company

Our Company was established as a limited liability company in the PRC on December 22, 2016 and was converted into a joint stock company with limited liability on July 18, 2024 under the laws of the PRC. As of the Latest Practicable Date, the registered share capital of our Company was RMB102,160,000.00 divided into 102,160,000.00 Shares with a nominal value of RMB1.00 each.

Our Company has established a place of business in Hong Kong at Room 504, 5/F, Cheong Tai Commercial Building, 60-66 Wing Lok Street, Sheung Wan, Hong Kong, and has registered as a non-Hong Kong company in Hong Kong under Part 16 of the Companies Ordinance on September 26, 2025. Ms. Ha Ching Ching (夏正靜), the joint company secretary of our Company, has been appointed as our authorized representative for the acceptance of service of process in Hong Kong whose correspondence address is the same as our place of business in Hong Kong.

2. Changes in Share Capital of Our Company

On December 22, 2016, our Company was established as a limited liability company with a registered capital of RMB1.00 million.

Save as disclosed in the section headed “History, Development and Corporate Structure” in this Document, there has been no alteration in our share capital within two years immediately preceding the date of this document.

3. Changes in the Share Capital of Our Subsidiaries

Our subsidiaries as of the Latest Practicable Date are set out in note 15 to the Accountants’ Report.

(a) *Zhongshan Rayson*

On March 25, 2024, Zhongshan Rayson was established as a limited liability company with a registered capital of RMB135.00 million.

On April 24, 2025, the share capital of Zhongshan Rayson was increased from RMB135.00 million to RMB185.00 million.

(b) *Artmem Technology*

On November 24, 2017, Artmem Technology was established as a limited liability company with a registered capital of RMB50.00 million.

On December 27, 2022, the share capital of Artmem Technology was increased from RMB50.00 million to RMB100.00 million.

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On December 14, 2023, the share capital of Artmem Technology was increased from RMB100.00 million to RMB150.00 million.

On December 26, 2024, the share capital of Artmem Technology was increased from RMB150.00 million to RMB200.00 million.

Save as disclosed, there had been no alteration in the share capital of our subsidiaries within two years immediately preceding the date of this document.

4. Resolutions of the Shareholders

Pursuant to a general meeting of our Company held on September 8, 2025, the following resolutions, among others, were passed by our Shareholders:

- (a) the [REDACTED] by our Company of H Shares of a nominal value of RMB1.00 each and that such H Shares be [REDACTED] on the [REDACTED];
- (b) that the number of H Shares to be [REDACTED] shall not be more than [REDACTED]% of the total issued share capital of our Company as enlarged by the [REDACTED] (without taking into account the H Shares which may be [REDACTED] and [REDACTED] pursuant to the exercise of the [REDACTED]), and the grant to the [REDACTED] (or their representatives) of the [REDACTED] of not more than [REDACTED]% of the number of H Shares issued pursuant to the [REDACTED];
- (c) subject to the completion of the [REDACTED], the adoption of the Articles of Association which shall become effective on the [REDACTED], and the authorization to the Board to amend the Articles of Association in accordance with the requirements of the relevant laws and regulations and the Listing Rules; and
- (d) authorization of the Board or its authorized person to handle all relevant matters relating to, among other things, the [REDACTED] and [REDACTED] of the H Shares.

FURTHER INFORMATION ABOUT THE BUSINESS OF OUR COMPANY

1. Summary of Material Contract

We have entered into the following contract (not being a contract entered into in the ordinary course of business) within the two years immediately preceding the date of this document that is or may be material:

- (a) [REDACTED].

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2. Intellectual Property Rights

(a) Trademarks

As of December 31, 2025, we have registered the following trademarks which we consider to be material to our business:

No.	Owner	Registration no.	Place of registration	Trademark	Class	Expiration date
1 . . .	Our Company	5095357	France		9, 35, 42	November 5, 2034
2 . . .	Our Company	76933704	PRC	妙存	9	June 13, 2035
3 . . .	Our Company	76937966	PRC	晶存	9	June 13, 2035
4 . . .	Our Company	76300391	PRC	RAYSMEM	42	July 6, 2034
5 . . .	Our Company	76309662	PRC	RAYSMEM	35	September 13, 2034
6 . . .	Our Company	76312617	PRC	RAYSMEM	9	September 13, 2034
7 . . .	Our Company	75003019	PRC		42	August 20, 2034
8 . . .	Our Company	74952293	PRC	妙存	9	June 13, 2035
9 . . .	Our Company	74952293A	PRC	妙存	9	June 20, 2034
10 . .	Our Company	74988662	PRC		9	September 6, 2034
11 . .	Our Company	74936906	PRC	晶存	35	June 13, 2035
12 . .	Our Company	74944593	PRC	晶存	9	June 13, 2035
13 . .	Our Company	74988692	PRC		42	April 20, 2034
14 . .	Our Company	75013034	PRC	RYP	9	April 20, 2034
15 . .	Our Company	74929804	PRC	妙存	35	June 13, 2035
16 . .	Our Company	58436674	PRC		35	July 13, 2033

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No.	Owner	Registration no.	Place of registration	Trademark	Class	Expiration date
17 . .	Our Company	58420611	PRC		42	June 6, 2032
18 . .	Our Company	42097185	PRC		9	July 13, 2030
19 . .	Our Company	23076277	PRC		35	May 13, 2028
20 . .	Our Company	23076278	PRC		35	May 13, 2028
21 . .	Our Company	29783343	PRC		9	February 6, 2029
22 . .	Our Company	29775828	PRC		9	February 6, 2029
23 . .	Our Company	17678455	PRC		9	October 6, 2026
24 . .	Our Company	17358585	PRC		9	September 6, 2026
25 . .	Artmem Technology	76806885	PRC		42	June 6, 2035
26 . .	Artmem Technology	29549522	PRC		9	February 6, 2029
27 . .	Artmem Technology	71623226A	PRC		9	April 13, 2034
28 . .	Artmem Technology	75096828	PRC		35	April 27, 2034
29 . .	Artmem Technology	75114050	PRC		42	April 27, 2034

(b) Domain Names

As of December 31, 2025, we have registered the following domain names which we consider to be material to our business:

No.	Owner	Domain name	Registration date
1 . . .	Our Company	szrayson.com	October 3, 2018
2 . . .	Artmem Technology	artmemtech.com	November 27, 2017

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(c) Copyrights

As of December 31, 2025, we have registered the following copyrights which we consider to be material to our business:

No.	Copyright	Registered owner	Registration number	First publication date	Registration date
1 . .	Rayson HI-TECH Information Storage and Backup Management System V1.0	Our Company	2019SR1283283	October 10, 2019	December 4, 2019
2 . .	Rayson HI-TECH Production Data Information Storage and Management System V1.0	Our Company	2019SR1282901	July 26, 2019	December 4, 2019
3 . .	Rayson HI-TECH Mass Information Data Storage and Management System V1.0	Our Company	2019SR1282893	July 22, 2019	December 4, 2019
4 . .	Rayson HI-TECH User Information Storage and Management System V1.0	Our Company	2019SR1309504	April 18, 2019	December 7, 2019
5 . .	Rayson HI-TECH File Information Storage and Upload System V1.0	Our Company	2019SR1310751	May 24, 2019	December 9, 2019
6 . .	Rayson HI-TECH Storage Chip Test Data Management System V1.0	Our Company	2019SR1376090	March 8, 2019	December 16, 2019
7 . .	Rayson HI-TECH Storage Chip Test Aging Environment Operation System V1.0	Our Company	2019SR1380644	May 16, 2019	December 17, 2019
8 . .	Rayson HI-TECH Mobile Hard Disk Storage Management System V1.0	Our Company	2019SR1388547	October 31, 2019	December 18, 2019
9 . .	Rayson HI-TECH Mobile Storage Device Test Management System V1.0	Our Company	2019SR1388529	August 15, 2019	December 18, 2019
10 . .	Rayson HI-TECH Network Attached Storage (NAS) Data Service System V1.0	Our Company	2019SR1388523	July 25, 2019	December 18, 2019
11 . .	Dram_Test_Rayson Software V1.0	Our Company	2022SR0272864	–	February 24, 2022
12 . .	Rayson_Dram_Test_Machine Software V1.0	Our Company	2021SR1353693	–	September 9, 2021
13 . .	eMMC Device Protocol Layer Driver Module Software V1.0	Artem Technology	2018SR787567	–	September 28, 2018

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No.	Copyright	Registered owner	Registration number	First publication date	Registration date
14. .	ATOS Software Development System V1.0	Artmem Technology	2018SR817816	–	October 15, 2018
15. .	Artmem eMMC Upgrade Tool Software V1.0	Artmem Technology	2020SR0248717	–	March 13, 2020
16. .	eMMC FTL Software Based on SLC NAND FLASH V1.0	Artmem Technology	2021SR1203027	–	August 13, 2021
17. .	Artmem FAE Assistant Mass Production Support Tool Software V1.0.0	Artmem Technology	2021SR1180964	–	August 10, 2021

(d) Patents

As of December 31, 2025, we have registered the following patents which wet consider to be material to our business. Under the PRC laws, the term of protection for invention patents is 20 years.

No.	Owner	Type	Patent	Registration No.	Place of Application
1. . .	Our Company	Invention	A Memory Testing Method, System, Device, and Storage Medium	CN202510113142.7	PRC
2. . .	Our Company	Invention	Batch Chip Testing Method Based on Power Supply Switching, and Its System, Equipment, and Medium	CN202510139269.6	PRC
3. . .	Our Company	Invention	Chip Testing Method, Device, Electronic Equipment, and Readable Storage Medium	CN202510139260.5	PRC
4. . .	Our Company	Invention	Functional Testing Method, Equipment, and Storage Medium for Random Access Memory (RAM)	CN202510102672.1	PRC
5. . .	Our Company	Invention	Test Pattern Determination Method for Chip Testing, and Controller, Equipment, and Medium	CN202510105849.3	PRC
6. . .	Our Company	Invention	Read-Write Testing Method, Equipment, and Storage Medium for Memory Devices	CN202510105856.3	PRC

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No.	Owner	Type	Patent	Registration No.	Place of Application
7. . .	Our Company	Invention	Consistency Testing Method, Device, Equipment, and Storage Medium for Memory Devices	CN202510093369.X	PRC
8. . .	Our Company	Invention	A Method, System, Device, and Storage Medium for Determining WCK-ON Value of LPDDR Chips	CN202510102669.X	PRC
9. . .	Our Company	Invention	Pattern Testing Method and Device, Equipment, and Medium for Single Die	CN202510082278.6	PRC
10. . .	Our Company	Invention	Timing Parameter Determination Method for Storage Chips, and Controller, Equipment, and Medium	CN202510082281.8	PRC
11. . .	Our Company	Invention	Method for Batch Chip Testing, and Its System, Electronic Equipment, and Storage Medium	CN202410436089.X	PRC
12. . .	Our Company	Invention	A Testing Method, System, Device, and Storage Medium for Dynamic Random Access Memory (DRAM)	CN202310461408.8	PRC
13. . .	Our Company	Invention	A Testing Method and Device for Dynamic Random Access Memory (DRAM)	CN202110722149.0	PRC
14. . .	Our Company	Invention	A Product Information Identification Method and Device for Multiple Memory Chips	CN202110720314.9	PRC
15. . .	Our Company	Invention	An Eye Diagram Testing Method, System, Equipment, and Medium	CN202210058875.1	PRC
16. . .	Our Company	Invention	DRAM Channel Testing Method, System, Device, and Storage Medium	CN202210960777.7	PRC
17. . .	Our Company	Invention	Multi-Interface Linked Display Method and System for Chip Testing	CN202310276706.X	PRC
18. . .	Our Company	Invention	Chip Test Data Query Method, System, Equipment, and Medium	CN202310279492.1	PRC

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No.	Owner	Type	Patent	Registration No.	Place of Application
19 . .	Our Company	Invention	A Storage Chip Testing Method, System, Device, and Storage Medium	CN202310366561.2	PRC
20 . .	Our Company	Invention	Capacity Reduction Testing Method, System, Equipment, and Storage Medium for LPDDR Chips	CN202310433004.8	PRC
21 . .	Our Company	Invention	Display Method, System, Device, and Storage Medium for Chip Test Results	CN202310447608.8	PRC
22 . .	Our Company	Invention	Chip Detection Method, System, Device, and Storage Medium	CN202310465912.5	PRC
23 . .	Our Company	Invention	Chip Testing Method, Device, Electronic Equipment, and Computer-Readable Storage Medium	CN202310459965.6	PRC
24 . .	Our Company	Invention	Chip Classification Method, Device, Electronic Equipment, and Computer-Readable Storage Medium	CN202310451376.3	PRC
25 . .	Our Company	Invention	Configuration Method, Device, Equipment, and Storage Medium for Memory Chip Test Fixtures	CN202310460687.6	PRC
26 . .	Our Company	Invention	System-Level Testing Method and System for Memory Products	CN202310446643.8	PRC
27 . .	Our Company	Invention	Storage Chip Testing Method, Device, Electronic Equipment, and Readable Storage Medium	CN202310460347.3	PRC
28 . .	Our Company	Invention	Method, Device, Electronic Equipment, and Storage Medium for Reducing Defect Rate of Storage Chips	CN202310473197.X	PRC
29 . .	Our Company	Invention	Temperature Chamber for Testing and Its Testing Method	CN202310477572.8	PRC
30 . .	Our Company	Invention	Chip Equipment Test Control Method, Upper Computer, Equipment, and Medium	CN202310477682.4	PRC
31 . .	Our Company	Invention	Word Line-Based Chip Performance Testing Method, Device, Equipment, and Medium	CN202310477357.8	PRC

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No.	Owner	Type	Patent	Registration No.	Place of Application
32 . .	Our Company	Invention	A Rapid Identification Method, Device, and Storage Medium for Abnormal Information	CN202310541197.9	PRC
33 . .	Our Company	Invention	Hard Disk Performance Testing Method, Device, and Medium	CN202310622949.4	PRC
34 . .	Our Company	Invention	Hard Disk Data Testing Method, Device, System, and Medium	CN202310505124.4	PRC
35 . .	Our Company	Invention	Hard Disk Wear Testing Method, Device, and Medium	CN202310505171.9	PRC
36 . .	Our Company	Invention	fio-Based Hard Disk Garbage Collection Method, Device, System, and Medium	CN202310508415.9	PRC
37 . .	Our Company	Invention	Test Mode Switching Method for Solid-State Drives (SSDs)	CN202310514187.6	PRC
38 . .	Our Company	Invention	Testing methods and storage media for solid-state drives	CN202310517363.1	PRC
39 . .	Our Company	Invention	Testing methods for solid-state drives	CN202310511840.3	PRC
40 . .	Our Company	Invention	Methods, systems, equipment, and storage media for board aging testing	CN202310640518.0	PRC
41 . .	Our Company	Invention	A data display method, system, device, and storage medium	CN202310755947.2	PRC
42 . .	Our Company	Invention	Data processing methods, devices, electronic devices, and storage media for NAND Flash	CN202310758043.5	PRC
43 . .	Our Company	Invention	A device testing method, controller, system, and medium for simulating game scenarios	CN202310803818.6	PRC
44 . .	Our Company	Invention	Data testing methods, electronic devices, and storage media	CN202410564929.0	PRC
45 . .	Artmem Technology	Invention	A method and device for improving the reliability of NAND flash memory data	CN201811260767.2	PRC
46 . .	Artmem Technology	Invention	A method for screening and grading flash memory particles	CN201910304340.6	PRC
47 . .	Artmem Technology	Invention	A method and device for storing data using its cold and hot attributes	CN201811268266.9	PRC
48 . .	Artmem Technology	Invention	Adaptive Flash Data Rereading Method, Device, and Media	CN202011495940.4	PRC

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No.	Owner	Type	Patent	Registration No.	Place of Application
49 . .	Artmem Technology	Invention	Decouple capacitor circuit structure	CN202111098500.X	PRC
50 . .	Artmem Technology	Invention	Phase synchronization method and circuit based on sampling of data gating signal	CN201911131266.9	PRC
51 . .	Artmem Technology	Invention	A method for reducing LDPC error level	CN201811064276.0	PRC
52 . .	Artmem Technology	Invention	Method, device, and medium for reducing trim consumption of flash memory devices	CN202110093578.6	PRC
53 . .	Artmem Technology	Invention	Data backup method, device, and flash memory system for MLC NAND	CN202110041077.3	PRC
54 . .	Artmem Technology	Invention	NAND erase method, device, and readable storage medium	CN202111597262.7	PRC
55 . .	Artmem Technology	Invention	A method, system, device, and storage medium for designing the pin layout of a chip carrier board	CN202210359180.7	PRC
56 . .	Artmem Technology	Invention	Output circuit module and anti-leakage push-pull circuit	CN201911212159.9	PRC
57 . .	Artmem Technology	Invention	Nand Flash Rereading Localization Method	CN202111238208.3	PRC
58 . .	Artmem Technology	Invention	Methods, devices, and media for improving MLC NAND performance	CN202110090429.4	PRC
59 . .	Artmem Technology	Invention	NAND writing and backup methods, systems, and media	CN202111336658.6	PRC
60 . .	Artmem Technology	Invention	A method for maintaining the timing of flash memory operations	CN201910332316.3	PRC
61 . .	Artmem Technology	Invention	IO PAD Metal Structure Layout and Its Design Method	CN202110978787.9	PRC
62 . .	Artmem Technology	Invention	PG PAD Metal Structure Layout and Its Design Method	CN202110979033.5	PRC
63 . .	Artmem Technology	Invention	Power down protection method, device, and medium for NAND FLASH data	CN202111352896.6	PRC
64 . .	Artmem Technology	Invention	Analysis Method and System for Flash Memory Characteristics	CN202010312948.6	PRC

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No.	Owner	Type	Patent	Registration No.	Place of Application
65 . .	Artmem Technology	Invention	An Accelerated Power Down and Reset Method and Circuit for Precise Control of Detection Threshold	CN201811181065.5	PRC
66 . .	Artmem Technology	Invention	A method for multi-channel shared LDPC encoder	CN201910025225.5	PRC
67 . .	Artmem Technology	Invention	A testing method, system, device, and storage medium	CN202211068386.0	PRC
68 . .	Artmem Technology	Invention	A chip parameter acquisition circuit	CN202211069092.X	PRC
69 . .	Artmem Technology	Invention	Flash garbage collection method, device, and readable storage medium	CN202211186299.5	PRC
70 . .	Artmem Technology	Invention	Data recovery methods, data recovery devices, solid-state drives, storage media	CN202211277529.9	PRC
71 . .	Artmem Technology	Invention	A Design Method and Device for Chip Virtual Components	CN202210637779.2	PRC
72 . .	Artmem Technology	Invention	A Layout Design Method for Low Voltage Tube Modules	CN202211144228.9	PRC
73 . .	Artmem Technology	Invention	A data storage and processing system and method based on RISC-V and its extended instructions	CN202310083012.4	PRC
74 . .	Artmem Technology	Invention	A backup data method, device, and electronic device for MLC NAND	CN202211432251.8	PRC
75 . .	Artmem Technology	Invention	Data recovery methods, devices, electronic devices, and media for flash memory	CN202211616424.1	PRC
76 . .	Artmem Technology	Invention	A segmented erasing method and system for flash virtual blocks	CN202211639781.X	PRC
77 . .	Artmem Technology	Invention	A command queue management method, system, device, and storage medium	CN202210838621.1	PRC
78 . .	Artmem Technology	Invention	A method and system for generating random sequence seeds for NAND Flash randomization	CN202310170602.0	PRC
79 . .	Artmem Technology	Invention	Flash controller and its method of accessing flash particles	CN202310471973.2	PRC
80 . .	Artmem Technology	Invention	Flash access system and method	CN202310482516.3	PRC

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No.	Owner	Type	Patent	Registration No.	Place of Application
81 . .	Artmem Technology	Invention	Descriptor management method	CN202310471467.3	PRC
82 . .	Artmem Technology	Invention	A method for hot plugging and unplugging chip testing equipment, testing equipment, and storage medium	CN202310369824.5	PRC
83 . .	Artmem Technology	Invention	A method for packaging memory chips, memory chips, and integrated circuit systems	CN202310547545.3	PRC
84 . .	Artmem Technology	Invention	Identification method, system, and storage medium for cold and hot data	CN202310588422.4	PRC
85 . .	Artmem Technology	Invention	Accelerated boot method, main control device, and solid-state drive for storage chips	CN202310614374.1	PRC
86 . .	Artmem Technology	Invention	Startup method, startup device, and storage medium for eMMC verification platform	CN202310614383.0	PRC
87 . .	Artmem Technology	Invention	A data storage method, controller, and readable storage medium for eMMC	CN202310507574.7	PRC
88 . .	Artmem Technology	Invention	A method, system, device, and storage medium for determining sampling points	CN202310784746.5	PRC
89 . .	Artmem Technology	Invention	A self-detection and self-reset method and system based on UFS	CN202211639995.7	PRC
90 . .	Artmem Technology	Invention	A chip selection method, system, device, and storage medium	CN202310465724.2	PRC
91 . .	Artmem Technology	Invention	EMMC information acquisition method and system, electronic devices, and storage media	CN202310465219.8	PRC
92 . .	Artmem Technology	Invention	Firmware storage method, firmware search method, device and medium	CN202310465337.9	PRC
93 . .	Artmem Technology	Invention	Universal flash memory storage chip and burning method	CN202310465261.X	PRC
94 . .	Artmem Technology	Invention	Power supply circuit and its implementation method, implementation device, storage medium	CN202310474851.9	PRC

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No.	Owner	Type	Patent	Registration No.	Place of Application
95 . .	Artmem Technology	Invention	A method, controller, and computer storage medium for improving the reliability of flash memory	CN202310366662.X	PRC
96 . .	Artmem Technology	Invention	Storage boot management method, system, device, and storage medium	CN202310525781.5	PRC
97 . .	Artmem Technology	Invention	Chip sleep state detection method and system, electronic devices, and storage media	CN202310537870.1	PRC
98 . .	Artmem Technology	Invention	Method, device, equipment, and medium for verifying the netlist of chip substrates	CN202310560127.8	PRC
99 . .	Artmem Technology	Invention	A testing method, system, device, and storage medium for flash memory	CN202310569141.4	PRC
100 . .	Artmem Technology	Invention	A hardware based sorting algorithm optimization method and its device	CN202310570791.0	PRC
101 . .	Artmem Technology	Invention	AHB interface equipment writing transmission method, device, electronic equipment, and readable storage medium	CN202310596567.9	PRC
102 . .	Artmem Technology	Invention	Data recovery methods and devices for flash memory, solid-state drives, and storage media	CN202310612948.1	PRC
103 . .	Artmem Technology	Invention	A data sampling method, system, chip, device, and storage medium	CN202310614357.8	PRC

Save as disclosed above, as of December 31, 2025, there was no other trade or service mark, patent, intellectual or industrial property right which was material in relation to our business.

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FURTHER INFORMATION ABOUT OUR DIRECTORS, SUPERVISORS AND SUBSTANTIAL SHAREHOLDERS

1. Disclosure of Interests

Save as disclosed below, immediately following completion of the [REDACTED] (without taking into account the H Shares which may be [REDACTED] and [REDACTED] pursuant to the exercise of the [REDACTED]), so far as our Directors are aware, none of our Directors, Supervisors and chief executive has any interest or short positions in our Shares, underlying Shares or debentures of our Company or any associated corporations (within the meaning of Part XV of the SFO) which will have to be notified to our Company and the [REDACTED] pursuant to [REDACTED] of Part XV of the SFO (including interests and short positions which they are taken or deemed to have under such provisions of the SFO), or which will be required, pursuant to [REDACTED] of the SFO, to be entered in the register referred to therein, or which will be required to be notified to our Company and [REDACTED] pursuant to the [REDACTED].

Name	Position	Capacity/ nature of interest	Number of Shares held	Approximate percentage of shareholding in the relevant proportion of Shares ⁽¹⁾⁽²⁾ (%)	Approximate percentage of shareholding in the total issued share capital of our Company ⁽¹⁾⁽²⁾ (%)
Mr. Wen Jianwei (文建偉) ⁽³⁾⁽⁴⁾⁽⁵⁾	Executive Director, chairman of our Board and general manager	Interest in controlled corporation	[REDACTED]	[REDACTED]	[REDACTED]
Mr. Gong Hui (龔暉) ⁽⁶⁾⁽⁷⁾	Executive Director and deputy general manager	Interest in controlled corporation	[REDACTED]	[REDACTED]	[REDACTED]

Notes:

- (1) For the avoidance of doubt, both Unlisted Shares and H Shares are ordinary Shares in the share capital of our Company and are considered as one class of Shares.
- (2) The calculation is based on the assumption that immediately following the completion of the [REDACTED], there will be a total number of [REDACTED] H Shares (including [REDACTED] H Shares converted from Unlisted Shares without taking into consideration the exercise of [REDACTED]) in issue.
- (3) As of the Latest Practicable Date, Rayson Management is a limited partnership established in the PRC, and is controlled by its general partner Mr. Wen Jianwei. Rayson Management is owned as to 50.00% by Chuangjia Yongli, 32.50% by Mr. Wen Jianwei and 17.50 % by Mr. Wen Jianxiong (文建雄). Chuangjia Yongli is controlled by its general partner, Mr. Wen Jianwei, and is owned as to 65.00% by Mr. Wen Jianwei. Therefore, Mr. Wen Jianwei is deemed to be interested in the Shares held by Rayson Management.

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- (4) As of the Latest Practicable Date, Mr. Wen Jianwei controlled Rayson Erhao as its general partner. As such, under the SFO, Mr. Wen Jianwei is deemed to be interested in the Shares held by Rayson Erhao as a beneficial owner.
- (5) As of the Latest Practicable Date, Mr. Wen Jianwei controlled Jingmiaocun as its general partner. As such, under the SFO, Mr. Wen Jianwei is deemed to be interested in the Shares held by Jingmiaocun as a beneficial owner.
- (6) As of the Latest Practicable Date, Mr. Gong Hui controlled Jingmiaoxin as its general partner. As such, under the SFO, Mr. Gong Hui is deemed to be interested in the Shares held by Jingmiaoxin as a beneficial owner.
- (7) As of the Latest Practicable Date, Mr. Gong Hui controlled Xinzhicun as its general partner. As such, under the SFO, Mr. Gong Hui is deemed to be interested in the Shares held by Xinzhicun as a beneficial owner.

2. Substantial Shareholders

For the information on the persons who will, immediately following the completion of the [REDACTED], have interests or short positions in our Shares or underlying Shares which would be required to be disclosed to our Company and the [REDACTED] under the provisions of [REDACTED] of Part XV of the SFO, see “Substantial Shareholders” in this document.

As of the Latest Practicable Date, our Directors were not aware of any other person (other than our Directors or chief executive) who will, immediately following completion of the [REDACTED], directly or indirectly, be interested in 10% or more of the nominal value of any class of share capital carrying rights to vote in all circumstances at general meetings of any member of our Group other than our Company.

3. Service Contracts

Each of our Directors and Supervisors [has entered] into a service contract with our Company. The principal particulars of these service contracts comprise (a) a term of office commencing on the date of the approval at the relevant Company’s general meeting and ending on the expiration of the term of office of the prevailing session of the Board (with respect to Directors); and (b) termination provisions in accordance with their respective terms.

Save as disclosed above, none of our Directors or Supervisors has or is proposed to have entered into any service contract with any member of our Group (excluding contracts expiring or determinable by any member of our Group within one year without payment of compensation other than statutory compensation).

4. Remuneration of Directors and Supervisors

Save as disclosed in the section headed “Directors, Supervisors and Senior Management” in this document and note 8 to the Accountants’ Report, for the three financial years ended December 31, 2023, 2024 and 2025, none of our Directors or Supervisors received other remunerations of benefits in kind from us.

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5. Disclaimers

- (a) Save as disclosed in this section and the section headed “History, Development and Corporate Structure” in this document, none of our Directors, Supervisors or any of the parties listed in the paragraph headed “— Other Information — 5. Qualifications of Experts” in this Appendix is:
 - (i) interested in our promotion, or in any assets which have been, within two years immediately preceding the date of this document, acquired or disposed of by or leased to us, or are proposed to be acquired or disposed of by or leased to any member of our Company; or
 - (ii) materially interested in any contract or arrangement subsisting at the date of this document which is significant in relation to our business.
- (b) Save in connection with the [REDACTED] and the [REDACTED], none of the parties listed in the paragraph headed “— Other Information — 5. Qualifications of Experts” in this Appendix.
 - (i) is interested legally or beneficially in any shares in any member of our Group; or
 - (ii) has any right (whether legally enforceable or not) to subscribe for or to nominate persons to subscribe for any securities in any member of our Group;
- (c) Save as disclosed in this section and the section headed “Directors, Supervisors and Senior Management” in this document, none of our Directors is a director or employee of a company that has an interest in the share capital of our Company which, once the H Shares are [REDACTED] on the [REDACTED], would have to be disclosed pursuant to Divisions 2 and 3 of Part XV of the SFO.
- (d) So far as is known to our Directors, none of our Directors or their respective close associates (as defined under the Listing Rules) or Shareholders who owns more than 5% of the issued shares of our Company has any interests in the five largest customers or the five largest suppliers of our Group.

OTHER INFORMATION

1. Estate Duty

Our Directors have been advised that no material liability for estate duty is likely to impose on our Company or any of our subsidiaries under the laws of the PRC.

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2. Litigation

As of the Latest Practicable Date, save as disclosed in “Business — Legal Proceedings and Compliance — Ongoing Trade Secret Legal Proceeding” in this document, no member of our Group was involved in any litigation, arbitration or claim of material importance, and, so far as we are aware, no litigation, arbitration or claim of material importance is pending or threatened against any member of our Group, which would have a material adverse effect on our financial condition or results of operations, taken as a whole.

3. Joint Sponsors

The Joint Sponsors have made an application on behalf of our Company to the [REDACTED] for the [REDACTED] of, and permission to [REDACTED], our H Shares. All necessary arrangements have been made to enable the securities to be admitted into [REDACTED].

The Joint Sponsors satisfy the independence criteria applicable to sponsors set out in Rule 3A.07 of the Listing Rules. Each of the Joint Sponsors will receive a fee of USD350,000 to act as a sponsor to our Company in connection with the [REDACTED].

4. Preliminary Expenses

As of the Latest Practicable Date, our Company has not incurred material preliminary expenses.

5. Qualifications of Experts

The qualifications of the experts (as defined under the Listing Rules and the Companies (Winding Up and Miscellaneous Provisions) Ordinance) who have given opinions and/or advice in this document are as follows:

Name	Qualifications
China Merchants Securities (HK) Co., Limited	Licensed corporation under the SFO to conduct Type 1 (dealing in securities), Type 2 (dealing in futures contracts), Type 4 (advising on securities), Type 6 (advising on corporate finance) and Type 9 (asset management) regulated activities
Guotai Junan Capital Limited	Licensed corporation under the SFO to conduct type 6 (advising on corporate finance) regulated activity as defined under the SFO

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Name	Qualifications
KPMG	Certified Public Accountants Public Interest Entity Auditor registered in accordance with the Accounting and Financial Reporting Council Ordinance
AllBright Law Offices	Company’s PRC legal adviser
Tiantong Law Firm	Company’s PRC legal adviser as to PRC intellectual property litigation matters
King & Wood	Company’s legal adviser as to international sanctions laws
Frost & Sullivan (Beijing) Inc., Shanghai Branch Co. .	Independent industry consultant

6. Consents

Each of the experts as referred to in the paragraph headed “— Other Information — 5. Qualifications of Experts” in this Appendix [has] given and has not withdrawn their respective written consents to the issue of this document with the inclusion of certificates, letters, opinions or reports and the references to their respective names in the form and context in which they are respectively included.

7. Taxation of Holders of H Shares

(a) *Hong Kong*

The sale, purchase and transfer of H Shares are subject to Hong Kong stamp duty. The current rate charged on each of the purchaser and seller is 0.1% of the consideration or, if higher, the fair value of the H Shares being sold or transferred. For further details in relation to taxation, see “Regulatory Overview” in this document.

(b) *Consultation with Professional Advisers*

Potential [REDACTED] in the [REDACTED] are urged to consult their professional tax advisers if they are in any doubt as to the taxation implications of [REDACTED], [REDACTED], [REDACTED] or [REDACTED] or [REDACTED] our H Shares (or exercising rights attached to them). None of our Company, our Directors, the Joint Sponsors, the [REDACTED], the [REDACTED], the [REDACTED], the [REDACTED], or any other person or party involved in the [REDACTED] accept responsibility for any tax effects on, or liabilities of, any person, resulting from the [REDACTED], [REDACTED], [REDACTED] or [REDACTED], [REDACTED] or the exercise of any rights in relation to our H Shares.

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8. No Material Adverse Change

Our Directors confirm that, as of the date of this document, there has been no material adverse change in the financial or trading position of our Company since [December 31, 2025] (being the latest balance sheet date of our consolidated financial statements as set out in the Accountants’ Report).

9. Promoters

The promoters of our Company are all then 34 shareholders of our Company as of July 18, 2024 before our conversion into a joint stock company with limited liability. Save as disclosed in the section headed “History, Development and Corporate Structure” in this document, within the two years preceding the date of this document, no cash, securities or other benefit has been paid, allotted or given or is proposed to be paid, allotted or given to any promoter in connection with the [REDACTED] and the related transactions described in this document.

10. Restrictions on Repurchase

For details, see “Regulatory Overview” in this document.

11. Binding Effect

This document shall have the effect, if an application is made in pursuance of it, of rendering all persons concerned bound by all of the provisions (other than the penal provisions) of sections 44A and 44B of the Companies (Winding Up and Miscellaneous Provisions) Ordinance so far as applicable.

12. Bilingual Document

The English and Chinese language versions of this document are being published separately, in reliance upon the exemption provided under section 4 of the Companies (Exemption of Companies and Prospectuses from Compliance with Provisions) Notice (Chapter 32L of the Laws of Hong Kong).

13. Miscellaneous

Save as otherwise disclosed in this document:

- (a) within the two years preceding the date of this document, (i) our Company has not issued nor agreed to issue any share or loan capital fully or partly paid either for cash or for a consideration other than cash; and (ii) no commission, discount, brokerage or other special term has been granted in connection with the issue or sale of any shares of our Company;

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- (b) no Share or loan capital of our Company, if any, is under option or is agreed conditionally or unconditionally to be put under option;
- (c) our Company has not issued nor agreed to issue any founder shares, management shares or deferred shares;
- (d) our Company has no outstanding convertible debt securities or debentures;
- (e) there is no arrangement under which future dividends are waived or agreed to be waived;
- (f) there has been no interruption in our business which may have or have had a significant effect on the financial position in the last 12 months;
- (g) our Company is not presently listed on any stock exchange or traded on any trading system; and
- (h) our Company is a joint stock limited company and is subject to the PRC Company Law.